

Electronic Patent Application Fee Transmittal

Application Number:	10565682			
Filing Date:	28-Jun-2006			
Title of Invention:	SILICON-CONTAINING POLYMER, PROCESS FOR PRODUCING THE SAME, HEAT-RESISTANT RESIN COMPOSITION, AND HEAT-RESISTANT FILM			
First Named Inventor/Applicant Name:	Kunikazu Tauchi			
Filer:	Marvin Jay Spivak/Michelle Munday			
Attorney Docket Number:	284679US0PCT			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Submission- Information Disclosure Stmt	1806	1	180	180
Total in USD (\$)				180